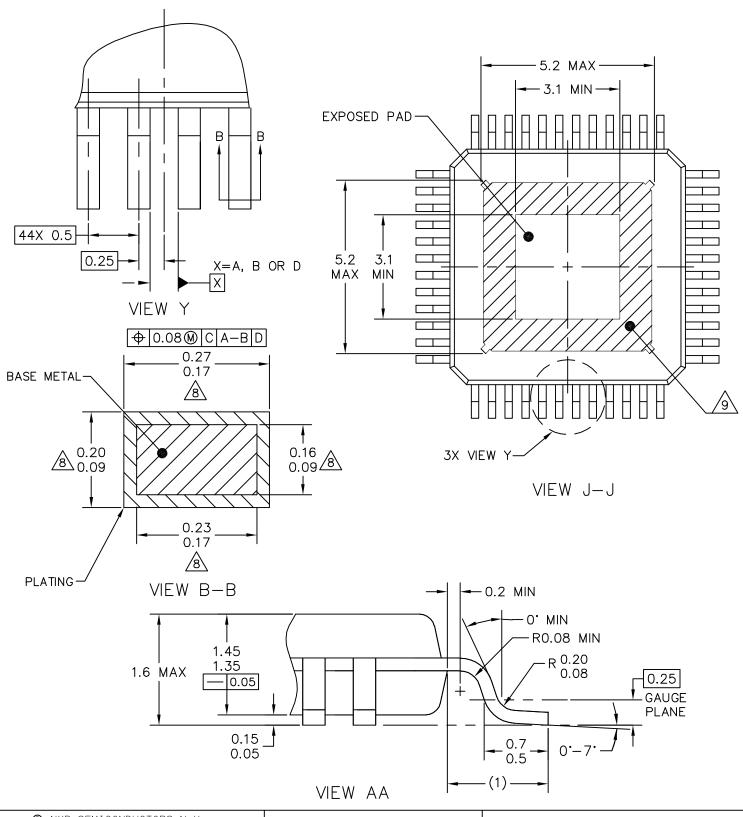


NXP SEMICONDUCTORS N. V. ALL RIGHTS RESERVED	MECHANICAL OUTLINE		PRINT VERSIO	N NOT TO SCALE
TITLE: 48 LEAD LQFP, 7X7X1.4 PKG, 0.5 PITCH, 4.15X4.15 EXPOSED PAD		DOCUMENT NO: 98ASA00737D REV: A		
		STANDARD: JEDEC MS-026 BBC		
0.5 TITOH, 4.15X4.15 EXI	OSLD I AD	SOT1571	1–3	12 JAN 2016





NXP SEMICONDUCTORS N. V. ALL RIGHTS RESERVED	MECHANICAL OUTLINE		PRINT VERSION NO	T TO SCALE
TITLE: 48 LEAD LQFP, 7X7X1.4 PKG, 0.5 PITCH, 4.15X4.15 EXPOSED PAD		DOCUMENT NO: 98ASA00737D REV: A		
		STANDARD: JEDEC MS-026 BBC		
0.0 1110H, 4.10/4.10 EX	1 OSED 1 AD	S0T157	1–3	12 JAN 2016



## NOTES:

- 1. DIMENSIONS ARE IN MILLIMETERS.
- 2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
- 3. DATUMS A, B AND D TO BE DETERMINED AT DATUM PLANE H.
- A DIMENSION TO BE DETERMINED AT SEATING PLANE C.
- THIS DIMENSION DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL NOT CAUSE THE LEAD WIDTH TO EXCEED THE UPPER LIMIT BY MORE THAN 0.08MM AT MAXIMUM MATERIAL CONDITION. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT. MINIMUM SPACE BETWEEN PROTRUSION AND ADJACENT LEAD SHALL NOT BE LESS THAN 0.07MM.
- THIS DIMENSION DOES NOT INCLUDE MOLD PROTRUSION. ALLOWABLE PROTRUSION IS 0.25MM PER SIDE. THIS DIMENSION IS MAXIMUM PLASTIC BODY SIZE DIMENSION INCLUDING MOLD MISMATCH.
- A EXACT SHAPE OF EACH CORNER IS OPTIONAL.
- AND 0.25MM FROM THE LEAD TIP.
- ATCHED AREA TO BE KEEP OUT ZONE FOR PCB ROUTING.

NXP SEMICONDUCTORS N.V. ALL RIGHTS RESERVED	MECHANICAL OUTLINE		PRINT VERSION NOT TO SCALE		
TITLE:  48 LEAD LQFP, 7X7X1.4 PKG,  0.5 PITCH, 4.15X4.15 EXPOSED PAD		DOCUMENT NO: 98ASA00737D REV: A			
		STANDARD: JEDEC MS-026 BBC			
0.5 PITCH, 4.15X4.15 EX	PUSED PAD	S0T1571	1–3	12 JAN 2016	